

Surface Mount Schottky Barrier Rectifier

Reverse Voltage - 20 to 200 V

Forward Current - 5 A

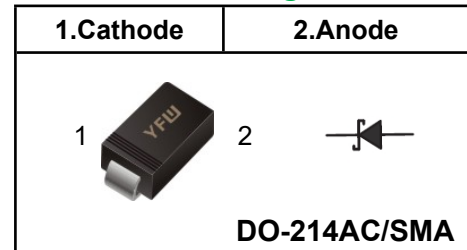
FEATURES

- ◆Metal silicon junction, majority carrier conduction
- ◆For surface mounted applications
- ◆Low power loss, high efficiency
- ◆High forward surge current capability
- ◆For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- ◆Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- ◆Case: DO-214AC/SMA
- ◆Terminals: Solderable per MIL-STD-750, Method 2026
- ◆Approx. Weight: 0.07g/0.002oz

Pinning



Marking Code

SS52	YFW SS52
SS54	YFW SS54
SS56	YFW SS56
SS58	YFW SS58
SS510	YFW SS510
SS512	YFW SS512
SS515	YFW SS515
SS520	YFW SS520

Absolute Maximum Ratings and Electrical characteristics

Ratings at 25 ° ambient temperature unless otherwise specified.Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbols	SS52	SS54	SS56	SS58	SS510	SS512	SS515	SS520	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	20	40	60	80	100	120	150	200	V
Maximum RMS voltage	V_{RMS}	14	28	42	56	70	84	105	140	V
Maximum DC Blocking Voltage	V_{DC}	20	40	60	80	100	120	150	200	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	5.0								A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed On Rated Load (JEDEC method)	I_{FSM}	120								A
Maximum Instantaneous Forward Voltage at 5 A	V_F	0.55		0.70		0.85		0.90		V
Maximum Instantaneous Reverse Current at Rated DC Reverse Voltage <small>$T_A = 25^{\circ}C$ $T_A = 100^{\circ}C$</small>	I_R	1.0 50								mA
Typical Junction Capacitance ⁽¹⁾	C_j	500				300				pF
Typical Thermal Resistance ⁽²⁾	$R_{\theta JA}$	60								°C/W
Operating Junction Temperature Range	T_j	-55 ~ +150								°C
Storage Temperature Range	T_{stg}	-55 ~ +150								°C

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Ratings And Characteristic Curves

Fig.1 Forward Current Derating Curve

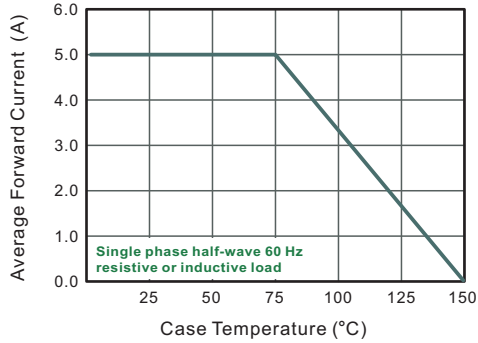


Fig.2 Typical Reverse Characteristics

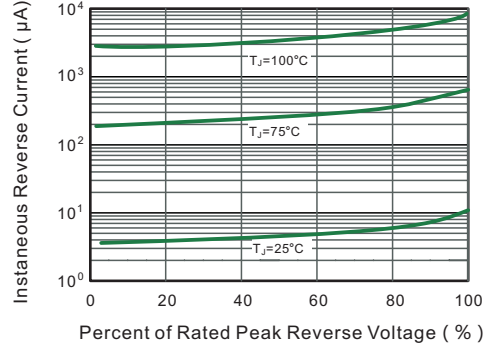


Fig.3 Typical Forward Characteristic

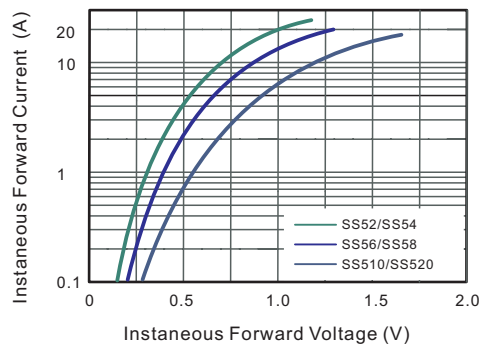


Fig.4 Typical Junction Capacitance

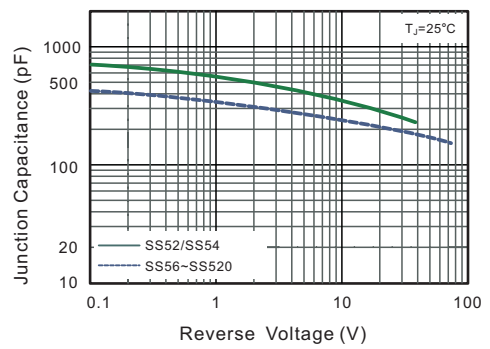


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

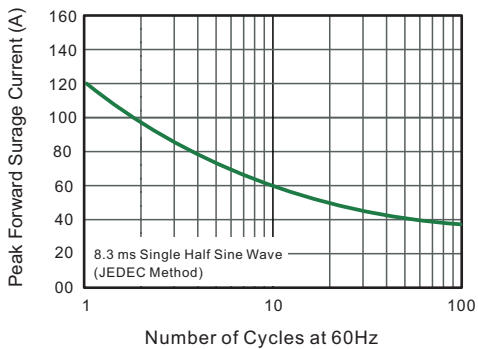
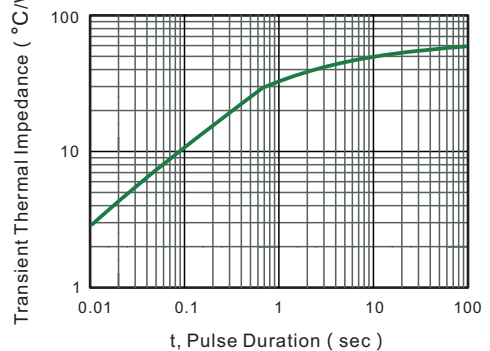


Fig.6- Typical Transient Thermal Impedance



Marking Diagram



Ordering information

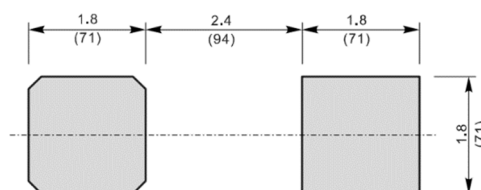
Package	Packing Description	Packing Quantity
DO-214AC SMA	Tape/Reel, 13" reel	5000PCS/Reel 50000PCS/Carton
	Tape/Reel, 7" reel	2000PCS/Reel 50000PCS/Carton

Package Dimensions

DO-214AC SMA

Dim.	Millimeter(mm)		mil	
	Min.	Max.	Min.	Max.
A	1.9	2.45	75	96
D	4.0	4.5	157	181
E	2.5	2.8	100	110
H _E	4.7	5.2	185	205
c	0.15	0.31	6	12
e	1.3	1.8	51	71
g	0.9	1.5	35	59
b	0.05	0.2	2	7.9
a	0.3		12	

The recommended mounting pad size



Unit : $\frac{\text{mm}}{\text{mil}}$

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